

Fractional-N Frequency Synthesizer

Data Sheet **[ADF4154](http://www.analog.com/ADF4154)**

FEATURES

RF bandwidth to 4 GHz 2.7 V to 3.3 V power supply Separate V_P allows extended tuning voltage **Programmable dual-modulus prescaler 4/5, 8/9 Programmable charge pump currents 3-wire serial interface Digital lock detect Power-down mode Pin compatible with th[e ADF4110](http://www.analog.com/adf4110)[/ADF4111/](http://www.analog.com/adf4111) [ADF4112](http://www.analog.com/adf4112)[/ADF4113,](http://www.analog.com/adf4113) [ADF4106,](http://www.analog.com/adf4106) [ADF4153](http://www.analog.com/adf4153)**

Programmable modulus on fractional-N synthesizer Trade-off noise vs. spurious performance Fast-lock mode with built-in timer Loop filter design possible with ADIsimPLL™

APPLICATIONS

Base stations for mobile radio (WiMAX, PHS, GSM, PCS, DCS, CDMA, PMR, W-CDMA, supercell 3G) Wireless handsets (PMR, GSM, PCS, DCS, CDMA, WCDMA) CATV equipment Wireless LANs Communications test equipment

GENERAL DESCRIPTION

The ADF4154 is a fractional-N frequency synthesizer that implements local oscillators in the up conversion and down conversion sections of wireless receivers and transmitters. It consists of a low noise digital phase frequency detector (PFD), a precision charge pump, and a programmable reference divider. There is a Σ - Δ based fractional interpolator to allow programmable fractional-N division. The INT, FRAC, and MOD registers define an overall N-divider (*N* = (*INT* + (*FRAC*/*MOD*))). In addition, the 4-bit reference counter (R-counter) allows selectable REF_{IN} frequencies at the PFD input. A complete phase-locked loop (PLL) can be implemented if the synthesizer is used with an external loop filter and a voltage-controlled oscillator (VCO).

A key feature of the ADF4154 is the fast-lock mode with a builtin timer. The user can program a predetermined countdown time value so that the PLL remains in wide bandwidth mode, instead of the user having to control this time externally.

Control of all on-chip registers is via a simple 3-wire interface. The device operates with a power supply ranging from 2.7 V to 3.3 V and can be powered down when not in use.

FUNCTIONAL BLOCK DIAGRAM

Rev. C

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REVISION HISTORY

8/12—Rev. B to Rev. C

5/04—Revision 0: Initial Version

SPECIFICATIONS

 $AV_{DD} = DV_{DD} = SDV_{DD} = 2.7 V$ to 3.3 V; $V_P = AV_{DD}$ to 5.5 V; AGND = DGND = 0 V; T_A = T_{MIN} to T_{MAX}, unless otherwise noted; dBm referred to 50 Ω. The operating temperature for the B version is −40°C to +80°C.

¹ Use a square wave for frequencies below f_{MIN}.
² AC coupling ensures AV_{DD}/2 bias. Se[e Figure 14](#page-8-8) for a typical circuit.

³ Guaranteed by design. Sample tested to ensure compliance.

⁴ The synthesizer phase noise floor is estimated by measuring the in-band phase noise at the output of the VCO and subtracting 20 log(N) (where N is the N divider value) and 10 $log(F_{\text{PPD}})$. PN_{SYNTH} = PN_{TOT} - 10 $log(F_{\text{PPD}})$ - 20 $log(N)$.

⁵ The PLL phase noise is composed of 1/f (flicker) noise plus the normalized PLL noise floor. The formula for calculating the 1/f noise contribution at an RF frequency, FRF, and at a frequency offset f is given by PN = PN_{1_f} + 10 log(10 kHz/f) + 20 log(F_{RF}/1 GHz). Both the normalized phase noise floor and flicker noise are modeled in ADIsimPLL. ⁶ The phase noise is measured with the EVAL-ADF4154EB1 and the HP8562E spectrum analyzer.

 7 f_{REFIN} = 26 MHz, f_{PFD} = 26 MHz, offset frequency = 1 kHz, RF_{OUT} = 1750 MHz, loop B/W = 20 kHz, lowest noise mode.

TIMING CHARACTERISTICS

 $AV_{DD} = DV_{DD} = SDV_{DD} = 2.7 V$ to 3.3 V; $V_P = AV_{DD}$ to 5.5 V; AGND = DGND = 0 V; T_A = T_{MIN} to T_{MAX}, unless otherwise noted; dBm referred to 50 Ω.

¹ Guaranteed by design, but not production tested.

Figure 2. Timing Diagram

ABSOLUTE MAXIMUM RATINGS

 $T_A = 25$ °C, unless otherwise noted.

Table 3.

¹ This device is a high performance RF-integrated circuit with an ESD rating of <2 kV, and it is ESD sensitive. Proper precautions should be taken when handling and assembling the device.

 2 GND = $A_{GND} = D_{GND} = 0$ V.

 $3 V_{DD} = AV_{DD} = DV_{DD} = SDV_{DD}$.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND PIN FUNCTION DESCRIPTIONS

Figure 3. TSSOP Pin Configuration

Table 4. Pin Function Descriptions

TYPICAL PERFORMANCE CHARACTERISTICS

Loop bandwidth = 20 kHz; reference = 250 MHz; VCO = Vari-L Company, Inc., VCO190-1750T; evaluation board = EVAL-ADF4154EB1; measurements taken with the Agilent E5500 phase noise measurement system.

Figure 5. Single-Sideband Phase Noise Plot (Lowest Noise Mode)

Figure 6. Single-Sideband Phase Noise Plot (Low Noise Mode and Spur Mode)

Figure 7. Single-Sideband Phase Noise Plot (Lowest Spur Mode)

Figure 8. PFD Noise Floor vs. PFD Frequency (Lowest Noise Mode)

Figure 10. Charge Pump Output Characteristics

CIRCUIT DESCRIPTION

REFERENCE INPUT SECTION

The reference input stage is shown in Figure 14. While the device is operating, usually SW1 and SW2 are closed switches and SW3 is open. When a power-down is initiated, SW3 is closed and SW1 and SW2 are opened. This ensures that the REFIN pin is not loaded while the device is powered down.

RF INPUT STAGE

The RF input stage is shown in [Figure 15.](#page-8-7) It is followed by a two-stage limiting amplifier to generate the current mode logic (CML) clock levels needed for the prescaler.

Figure 15. RF Input Stage

RF INT DIVIDER

The RF INT CMOS counter allows a division ratio in the PLL feedback counter. Division ratios from 31 to 511 are allowed.

INT, FRAC, MOD, AND R RELATIONSHIP

The INT, FRAC, and MOD values, in conjunction with the R-counter, enable generating output frequencies that are spaced by fractions of the PFD. See the [RF Synthesizer: A Worked Example](#page-17-1) section for more information. The RF VCO frequency (RF_{OUT}) equation is

$$
RF_{OUT} = F_{PFD} \times (INT + (FRAC/MOD))
$$
\n(1)

where *RF_{OUT}* is the output frequency of the external voltagecontrolled oscillator (VCO).

$$
F_{\rm PFD} = REF_{\rm IN} \times (1+D)/R \tag{2}
$$

where:

REFIN is the reference input frequency.

 D is the REF_{IN} doubler bit.

R is the preset divide ratio of binary 4-bit programmable reference counter (1 to 15).

INT is the preset divide ratio of binary 9-bit counter (31 to 511). *MOD* is the preset modulus ratio of binary 12-bit programmable FRAC counter (2 to 4095).

FRAC is the preset fractional ratio of binary 12-bit programmable FRAC counter (0 to MOD-1).

R-COUNTER

The 4-bit R-counter allows the input reference frequency (REF_{IN}) to be divided down to produce the reference clock to the PFD. Division ratios from 1 to 15 are allowed.

PHASE FREQUENCY DETECTOR (PFD) AND CHARGE PUMP

The PFD takes inputs from the R-counter and N-counter and produces an output proportional to the phase and frequency difference between them. [Figure 17](#page-8-9) is a simplified schematic. The PFD includes a fixed delay element that sets the width of the antibacklash pulse, which is typically 3 ns. This pulse ensures that there is no dead zone in the PFD transfer function and gives a consistent reference spur level.

MUXOUT AND LOCK DETECT

The output multiplexer on the ADF4154 allows the user to access various internal points on the chip. The state of MUXOUT is controlled by M3, M2, and M1 (see [Table 8\)](#page-12-0). Figure 18 shows the MUXOUT section in block diagram form.

The N-channel, open-drain, analog lock detect should be operated with an external pull-up resistor of 10 kΩ nominal. When lock has been detected, the lock detect is high with narrow low-going pulses.

Figure 18. MUXOUT Schematic

INPUT SHIFT REGISTERS

The ADF4154 digital section includes a 4-bit R value, a 9-bit RF N value, a 12-bit RF FRAC value, and a 12-bit interpolator modulus value/fast-lock timer. Data is clocked MSB first into the 24-bit shift register on each rising edge of CLK.

Data is transferred from the shift register to one of four latches on the rising edge of LE. The destination latch is determined by the state of the two control bits (C2 and C1) in the shift register. These are the two LSBs, DB1 and DB0, as shown i[n Figure 2.](#page-3-1) The truth table for these bits is shown in [Table 5.](#page-9-3) [Table 6](#page-10-1) shows a summary of how the latches are programmed.

PROGRAM MODES

[Table 5](#page-9-3) through [Table 9](#page-13-0) show how to set up the program modes in the ADF4154.

The ADF4154 programmable modulus is double buffered, meaning that two events must occur before the part can use a new modulus value. The first event is that the new modulus value must be latched into the device by writing to the R-divider register, and the second event is that a new write must be performed on the N-divider register. Therefore, whenever the modulus value is updated, the N-divider register must be written to so that the modulus value is loaded correctly.

Table 5. C2 and C1 Truth Table

REGISTERS

Table 6. Register Summary

R-DIVIDER REG

CONTROL REG

NOISE AND SPUR REG

04833-020 04833-020

Table 7. N-Divider Register Map

Table 8. R-Divider Register Map

Table 9. Control Register Map

Table 10. Noise and Spur Register

REGISTER DEFINITIONS

N-Divider Register, R0

The on-chip N-divider register is programmed by setting R0 [1, 0] to [0, 0]. [Table 7](#page-11-0) shows the input data format for programming this register.

9-Bit RF N Value (INT)

These nine bits control what is loaded as the INT value. This is used to determine the overall feedback division factor (see Equation 1).

12-Bit RF FRAC Value

These 12 bits control what is loaded as the FRAC value into the fractional interpolator. This value helps determine the overall feedback division factor (see Equation 1). The FRAC value must be less than the value loaded into the MOD register.

Fast Lock

Setting the part to logic high enables fast-lock mode. To use fast lock, the required time value for wide bandwidth mode must be loaded into the R-divider register.

The charge pump current increases from $16\times$ the minimum current and reverts back to $1\times$ the minimum current after the time value loaded expires.

See the [Fast-Lock Timer and Register Sequences](#page-18-0) section for more information.

R-DIVIDER REGISTER, R1

The on-chip R-divider register is programmed by setting R1 [1, 0] to [0, 1]. [Table 8](#page-12-0) shows the input data format for programming this register.

Load Control

When this bit is set to logic high, the value being programmed in the modulus is not loaded into the modulus. Instead, it sets the fast-lock timer. The value of the fast-lock timer divided by fPFD is the amount of time the PLL stays in wide bandwidth mode.

MUXOUT

The on-chip multiplexer is controlled by R1 [22 ... 20] on the ADF4154. [Table 8](#page-12-0) shows the truth table.

Digital Lock Detect

The digital lock detect output goes high if there are 40 successive PFD cycles with an input error of less than 15 ns. It stays high until a new channel is programmed or until the error at the PFD input exceeds 30 ns for one or more cycles. If the loop bandwidth is narrow compared with the PFD frequency, the error at the PFD inputs may drop below 15 ns for 40 cycles around a cycle slip. Therefore, the digital lock detect may briefly, and falsely, go high until the error exceeds 30 ns. In this case, the digital lock detect is reliable only as a loss-of-lock detector.

Prescaler (P/P + 1)

The dual-modulus prescaler $(P/P + 1)$, along with the INT, FRAC, and MOD counters, determines the overall division ratio from the RF_{IN} to the PFD input. Operating at CML levels, the prescaler uses the clock from the RF input stage and divides it down for the counters. The prescaler is based on a synchronous 4/5 core. When it is set to 4/5, the maximum RF frequency allowed is 2 GHz. Therefore, when operating the ADF4154 with frequencies greater than 2 GHz, the prescaler must be set to 8/9. The prescaler limits the INT value as follows:

With $P = 4/5$, $N_{MIN} = 31$ $With P = 8/9, N_{MIN} = 91$

The prescaler can also influence the phase noise performance. If INT < 91, a prescaler of 4/5 should be used. For applications where $INT > 91$, a prescaler of 8/9 should be used for optimum noise performance (se[e Table 8\)](#page-12-0).

4-Bit R Value

The 4-bit R value allows the input reference frequency (REF_{IN}) to be divided down to produce the reference clock for the PFD. Division ratios from 1 to 15 are allowed.

12-Bit Interpolator Modulus Value/Fast-Lock Timer

Depending on the value of the load control bit, Bits DB13:DB2 can either be used to set the modulus or the fast-lock timer value.

When the load control bit (DB23) is set to 0, the required modulus can be programmed in the R-divider register (DB13:DB2).

When the load control bit (DB23) is set to 1, the required fastlock timer value can be programmed in the R-divider register (DB13:DB2).

This programmable register sets the fractional modulus, which is the ratio of the PFD frequency to the channel step resolution on the RF output. Refer to th[e RF Synthesizer: A Worked](#page-17-1) [Example](#page-17-1) section for more information.

The ADF4154 programmable modulus is double buffered, meaning that two events must occur before the part can use a new modulus value. The first event is that the new modulus value must be latched into the device by writing to the R-divider register, and the second event is that a new write must be performed on the N-divider register. Therefore, whenever the modulus value is updated, the N-divider register must be written to so that the modulus value is loaded correctly.

CONTROL REGISTER, R2

The on-chip control register is programmed by setting R2 [1, 0] to [0, 1][. Table 9](#page-13-0) shows the input data format for programming this register.

RF Counter Reset

DB2 is the RF counter reset bit for the ADF4154. When this bit is set to 1, the RF synthesizer counters are held in reset. For normal operation, this bit should be set to 0.

RF Charge Pump Three-State

This bit (DB3) puts the charge pump into three-state mode when it is programmed to 1. For normal operation, it should be set to 0.

RF Power-Down

DB4 on the ADF4154 provides the programmable power-down mode. Setting Bit DB4 to 1 powers down the device. Setting Bit DB4 to 0 returns the synthesizer to normal operation. While in software power-down mode, the part retains all information in its registers. Only when supplies are removed are the register contents lost.

When a power-down is activated, the following events occur:

- 1. All active dc current paths are removed.
- 2. The synthesizer counters are forced to their load state conditions.
- 3. The charge pump is forced into three-state mode.
- 4. The digital lock detect circuitry is reset.
- 5. The RFIN input is debiased.
- 6. The input register remains active and capable of loading and latching data.

Lock Detect Precision (LDP)

When the LDP bit (DB5) is programmed to 0, 24 consecutive reference cycles of 15 ns must occur before the digital lock detect is set. When this bit is programmed to 1, 40 consecutive reference cycles of 15 ns must occur before digital lock detect is set.

Phase Detector Polarity

DB6 sets the phase detector polarity. When the VCO characteristics are positive, this bit should be set to 1. When they are negative, this bit should be set to 0.

Charge Pump (CP) Current Setting and CP/2

DB7, DB8, DB9, and DB10 set the charge pump current, which should be set according to the loop filter design (see [Table 9\)](#page-13-0).

REFIN Doubler

Setting the REF_{IN} doubler bit (DB11) to 0 feeds the REF_{IN} signal directly to the 4-bit R-counter, which disables the doubler. Setting the REF_{IN} doubler bit to 1 multiplies the REF_{IN} frequency by a factor of 2 before feeding into the 4-bit R-counter. When the doubler is disabled, the REF_{IN} falling edge is the active edge at the PFD input to the fractional synthesizer. When the doubler is enabled, both the rising and falling edges of REF_{IN} become active edges at the PFD input.

When the doubler is enabled and the lowest spur mode is chosen, the in-band phase noise performance is sensitive to the REF_{IN} duty cycle. The phase noise degradation can be as much as 5 dB for the REF_{IN} duty cycles outside a 45% to 55% range. The phase noise is insensitive to the REF_{IN} duty cycle in the lowest noise mode and in the lowest noise and spur mode. The phase noise is insensitive to the REF_{IN} duty cycle when the doubler is disabled.

The maximum allowed REF_{IN} frequency when the doubler is enabled is 30 MHz.

NOISE AND SPUR REGISTER, R3

The on-chip noise and spur register is programmed by setting R3 [1, 0] to [1, 1].

[Table 10](#page-14-0) shows the input data format for programming this register.

Noise and Spur Mode

Noise and spur mode allows the user to optimize a design either for improved spurious performance or for improved phase noise performance. When the lowest spur setting is chosen, dither is enabled. This randomizes the fractional quantization noise so that it looks more like white noise than spurious noise, meaning that the part is optimized for improved spurious performance. This operation is typically used when the PLL closed-loop bandwidth is wide for fast-locking applications. A wide-loop bandwidth is defined as a loop bandwidth greater than $1/10$ of the RF_{OUT} channel step resolution (fRES). A wide-loop filter does not attenuate the spurs to a level that a narrow-loop bandwidth would. When the low noise and spur setting is enabled, dither is disabled. This optimizes the synthesizer to operate with improved noise performance. However, the spurious performance is degraded in this mode compared with the lowest spur setting. To further improve noise performance, the lowest noise setting option can be used, which reduces the phase noise. As well as disabling the dither, it ensures that the charge pump operates in an optimum region for noise performance. This setting is extremely useful if a narrow-loop filter bandwidth is used. The synthesizer ensures extremely low noise, and the filter attenuates the spurs. The typical performance characteristics show the trade-offs in a typical WCDMA setup for different noise and spur settings.

RESERVED BITS

These bits should be set to 0 for normal operation.

INITIALIZATION SEQUENCE

The following initialization sequence should be followed after powering up the part:

- 1. Clear all test modes by writing all 0s to the noise and spur register.
- 2. Select the noise and spur mode required for the application by writing to the noise and spur register. For example, writing Hex 0003C7 to the part selects low noise mode.
- 3. Enable the counter reset in the control register by writing a 1 to DB2 and selecting the required settings in the control register.
- 4. Load the R-divider register (with the load control bit [DB23] set to 0).
- 5. Load the N-divider register.
- 6. Disable the counter reset by writing a 0 to DB2 in the control register.

The part should now lock to the set frequency.

RF SYNTHESIZER: A WORKED EXAMPLE

This equation governs how the synthesizer should be programmed.

$$
RF_{OUT} = [INT + (FRAC/MOD)] \times [f_{PFD}] \tag{3}
$$

where:

RF_{ouT} is the RF frequency output. *INT* is the integer division factor. *FRAC* is the fractionality. *MOD* is the modulus.

The PFD frequency can be calculated as follows:

 $f_{PFD} = [REF_{IN} \times (1 = D)/R]$ (4)

where:

REFIN is the reference frequency input. *D* is the value of the RF REF_{IN} doubler bit. *R* is the RF reference division factor.

For example, in a GSM 1800 system, where a 1.8 GHz RF frequency output (RF_{OUT}) is required, a 13 MHz reference frequency input (REF_{IN}) is available and a 200 kHz channel resolution (fRES) is required on the RF output.

$$
MOD = REF_{IN}/f_{RES}
$$

$$
MOD = 13 MHz/200 kHz = 65
$$

From Equation 4,

$$
f_{PFD} = [13 \text{ MHz} \times (1+0)/1] = 13 \text{ MHz} \tag{5}
$$

$$
1.8 \text{ GHz} = 13 \text{ MHz} \times (\text{INT} + \text{FRAC}/65) \tag{6}
$$

where: INT is 138. FRAC is 30.

MODULUS

The choice of modulus (MOD) depends on the reference signal (REF_{IN}) available and the channel resolution (f_{RES}) required at

the RF output. For example, a GSM 1800 system using a 13 MHz REFIN sets the modulus to 65, resulting in meeting the required RF output resolution (f_{RES}) of 200 kHz (13 MHz/65).

REFERENCE DOUBLER AND REFERENCE DIVIDER

The on-chip reference doubler allows the input reference signal to be doubled. This is useful for increasing the PFD comparison frequency, which in turn improves the noise performance of the system. For example, doubling the PFD frequency usually results in an improvement in noise performance of 3 dB. It is important to note that the PFD cannot operate with frequencies greater than 32 MHz due to a limitation in the speed of the Σ-Δ circuit of the N-divider.

12-BIT PROGRAMMABLE MODULUS

Unlike most fractional-N PLLs, the ADF4154 allows the user to program the modulus over a 12-bit range. Therefore, several configurations of the ADF4154 are possible for an application by varying the modulus value, the reference doubler, and the 4-bit R-counter.

For example, consider an application that requires a 1.75 GHz RF and a 200 kHz channel step resolution. The system has a 13 MHz reference signal.

One possible setup is feeding the 13 MHz REF_{IN} directly into the PFD and programming the modulus to divide by 65, which results in the required 200 kHz resolution.

Another possible setup is using the reference doubler to create a 26 MHz input frequency from the 13 MHz REF_{IN} signal. The 26 MHz signal is then fed into the PFD, which programs the modulus to divide by 130. This setup also results in 200 kHz resolution, plus it offers superior phase noise performance compared with the previous setup.

The programmable modulus is also very useful for multistandard applications. If a dual-mode phone requires PDC and GSM 1800 standards, the programmable modulus is a huge benefit. The PDC requires a 25 kHz channel step resolution, whereas the GSM 1800 requires a 200 kHz channel step resolution. A 13 MHz reference signal could be fed directly to the PFD. The modulus would be programmed to 520 when in PDC mode (13 MHz/520 = 25 kHz). The modulus would be reprogrammed to 65 for GSM 1800 operation (13 MHz/65 = 200 kHz). It is important that the PFD frequency remains constant (13 MHz). By keeping the PFD constant, the user can design a one-loop filter that can be used in both setups without running into stability issues. The ratio of the RF frequency to the PFD frequency affects the loop design. By keeping this relationship constant, the same loop filter can be used in both applications.

SPURIOUS OPTIMIZATION AND FAST LOCK

The ADF4154 can be optimized for low spurious signals by using the noise and spur register. However, to achieve fast-lock time, a wider loop bandwidth is needed. Note that a wider loop

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bandwidth can lead to notable spurious signals, which cannot be reduced significantly by the loop filter.

Using the fast-lock feature can achieve the same fast-lock time as the noise and spur register, but with the advantage of lower spurious signals because the final loop bandwidth is reduced by a quarter.

FAST-LOCK TIMER AND REGISTER SEQUENCES

If the fast-lock mode is used, a timer value needs to be loaded into the PLL to determine the time spent in wide bandwidth mode.

When the load control bit is set to 1, the timer value is loaded via the 12-bit modulus value. To use fast lock, the PLL must be written to in the following sequence:

- 1. Load the R-divider register with DB23 = 1 and the chosen fast-lock timer value (DB13 to DB2) instead of the modulus. Note that the duration that the PLL remains in wide bandwidth is equal to the fast-lock timer/fPFD.
- 2. Load the noise and spur register.
- 3. Load the control register.
- 4. Load the R-divider register with DB23 = 0 and MUXOUT = 110 (DB22 to DB20). This sets the fast-lock switch to appear at the MUXOUT pin. All the other needed parameters, including the modulus, also need to be loaded.
- 5. Load the N-divider register, including fast lock = 1 (DB23), to activate fast-lock mode.

After this procedure is complete, the user need only repeat Step 5 to invoke fast lock for subsequent frequency jumps.

FAST LOCK: AN EXAMPLE

If a PLL has reference frequencies of 13 MHz and $f_{\text{PP}} = 13 \text{ MHz}$ and a required lock time of 50 µs, the PLL is set to wide bandwidth for 40 μ s.

If the time period set for the wide bandwidth is $40 \mu s$, then

Fast-Lock Timer Value = *Time in Wide Bandwidth* \times *fPFD*

Fast-Lock Timer Value = 40 µs × 13 MHz = 520

Therefore, 520 must be loaded into the R-divider register in Step 1 of the sequence described in the [Fast-Lock Timer and](#page-18-0) [Register Sequences](#page-18-0) section.

FAST LOCK: LOOP FILTER TOPOLOGY

To use fast-lock mode, an extra connection from the PLL to the loop filter is needed. The damping resistor in the loop filter must be reduced to ¼ of its value while in wide bandwidth mode. This is required because the charge pump current is increased by 16 while in wide bandwidth mode, and stability must be ensured. During fast lock, the MUXOUT pin is shorted to ground (the fast-lock switch must be programmed to appear at the MUXOUT pin). The following two topologies can be used:

• Divide the damping resistor (R1) into two values (R1 and R1A) that have a ratio of 1:3 (see Figure 19).

• Connect an extra resistor (R1A) directly from MUXOUT, as shown in Figure 19. The extra resistor must be chosen such that the parallel combination of an extra resistor and the damping resistor $(R1)$ is reduced to $\frac{1}{4}$ of the original value of R1 (se[e Figure 20\)](#page-18-4).

Figure 20. Fast-Lock Loop Filter Topology—Topology 2

SPUR MECHANISMS

The following section describes three spur mechanisms that can arise when using a fractional-N synthesizer and how to minimize them in the ADF4154.

Fractional Spurs

The fractional interpolator in the ADF4154 is a third-order Σ-Δ modulator (SDM) with a modulus MOD that is programmable to an integer value between 2 and 4095. In low spur mode (dither enabled), the minimum allowed value of MOD is 50. The SDM is clocked at the PFD reference rate (f_{PP}) that allows PLL output frequencies to be synthesized at a channel step resolution of fPFD/MOD.

In low noise mode and low noise and spur mode (dither off), the quantization noise from the Σ - Δ modulator appears as fractional spurs. The interval between spurs is f_{PP}/L , where L is the repeat length of the code sequence in the digital Σ -Δ modulator. For the third-order modulator used in the ADF4154, the repeat length depends on the value of MOD, as shown i[n Table 11.](#page-18-5)

Table 11. Fractional Spurs with Dither Off

In low spur mode (dither enabled), the repeat length is extended to 2^{21} cycles, regardless of the value of MOD, which makes the quantization error spectrum appear as broadband noise. This can degrade the in-band phase noise at the PLL output by as much as 10 dB. Therefore, for lowest noise, dither off is a better choice, particularly when the final loop BW is low enough to attenuate even the lowest frequency fractional spur.

Integer Boundary Spurs

Another mechanism for fractional spur creation are interactions between the RF VCO frequency and the reference frequency. When these frequencies are not integer related (as is the case with fractional-N synthesizers), spur sidebands appear on the VCO output spectrum at an offset frequency that corresponds to the beat note or the difference in frequency between an integer multiple of the reference and the VCO frequency.

These spurs are attenuated by the loop filter and are more noticeable on channels close to integer multiples of the reference, where the difference frequency can be inside the loop bandwidth, thus the name integer boundary spurs.

Reference Spurs

Reference spurs are generally not a problem in fractional-N synthesizers because the reference offset is far outside the loop bandwidth. However, any reference feedthrough mechanism that bypasses the loop can cause a problem. One such mechanism is feedthrough of low levels of on-chip reference switching noise through the RFIN pin back to the VCO, resulting in reference spur levels as high as –90 dBc. Care should be taken in the PCB layout to ensure that the VCO is well separated from the input reference to avoid a possible feedthrough path on the board.

SPUR CONSISTENCY

When jumping from Frequency A to Frequency B and then back again using fractional-N synthesizers, the spur levels often differ each time Frequency A is programmed. However, in the ADF4154, the spur levels on any particular channel are always consistent.

FILTER DESIGN—ADIsimPLL

A filter design and analysis program is available to help the user implement the PLL design. Visit www.analog.com/pll for a free download of the ADIsimPLL software. The software designs, simulates, and analyzes the entire PLL frequency and time domain response. Various passive and active filter architectures are allowed.

INTERFACING

The ADF4154 has a simple, SPI®-compatible serial interface for writing to the device. SCLK, SDATA, and LE control the data transfer. When LE (latch enable) is high, the 22 bits that have been clocked into the input register on each rising edge of SCLK are transferred to the appropriate latch. See [Figure 2](#page-3-1) for the timing diagram and [Table 5](#page-9-3) for the latch truth table.

The maximum allowable serial clock rate is 20 MHz. This means that the maximum update rate possible for the device is 909 kHz or one update every 1.1 µs.

ADuC812 Interface

[Figure 21](#page-19-3) shows the interface between the ADF4154 and the ADuC812 MicroConverter®. Because the ADuC812 is based on an 8051 core, this interface can be used with any 8051-based microcontroller. The MicroConverter is set up for SPI master mode with CPHA set to 0. To initiate the operation, bring the I/O port driving LE low. Each latch of the ADF4154 requires a 24-bit word, which is accomplished by writing three 8-bit bytes from the MicroConverter to the device. After the third byte is written, the LE input should be brought high to complete the transfer.

When operating in the mode described, the maximum SCLOCK rate of the ADuC812 is 4 MHz. This means that the maximum rate at which the output frequency can be changed is 180 kHz.

Figure 21. ADuC812-to-ADF4154 Interface

ADSP-21xx Interface

[Figure 22](#page-19-4) shows the interface between the ADF4154 and the ADSP-21xx digital signal processor. As discussed previously, the ADF4154 requires a 24-bit serial word for each latch write. The easiest way to accomplish this using a device in the ADSP-21xx family is to use the autobuffered transmit mode of operation with alternate framing. This provides a means for transmitting an entire block of serial data before an interrupt is generated. Set up the word length for eight bits and use three memory locations for each 24-bit word. To program each 24-bit latch, store each of the three 8-bit bytes, enable the autobuffered mode, and write to the transmit register of the DSP. This last operation initiates the autobuffered transfer.

Figure 22. ADSP-21xx-to-ADF4154 Interface

PCB DESIGN GUIDELINES FOR CHIP SCALE PACKAGE

The lands on the chip scale package (CP-20-1) are rectangular. The printed circuit board pad for these should be 0.1 mm longer than the package land length and 0.05 mm wider than the package land width. The land should be centered on the pad. This ensures that the solder joint size is maximized.

The bottom of the chip scale package has a central thermal pad. The thermal pad on the printed circuit board should be at least as large as this exposed pad. On the printed circuit board, there should be a clearance of at least 0.25 mm between the thermal pad and the inner edges of the pad pattern to avoid shorting.

Thermal vias may be used on the printed circuit board thermal pad to improve thermal performance of the package. If vias are used, they should be incorporated into the thermal pad at 1.2 mm pitch grid. The via diameter should be between 0.3 mm and 0.33 mm, and the via barrel should be plated with 1 oz of copper to plug the via.

The user should connect the printed circuit board thermal pad to AGND.

OUTLINE DIMENSIONS

4 mm × 4 mm Very Very Thin Quad, (CP-20-6) Dimensions shown in millimeters

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ORDERING GUIDE

¹ Z = RoHS Compliant Part.

NOTES

NOTES

I 2 C refers to a communications protocol originally developed by Philips Semiconductors (now NXP Semiconductors).

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